2N6439

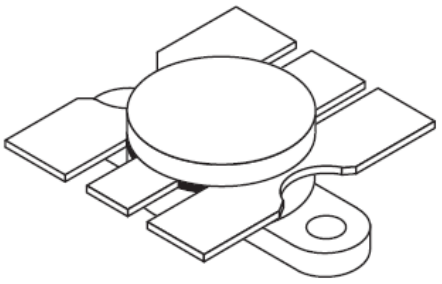
The RF Line NPN Silicon Power Transistor
60 W, 225 - 400 MHz, 28 V

Rev. V1

- Guaranteed performance in 225 to 400 MHz broadband amplifier @ 28 Vdc
  - Output power = 60 W over 225 to 400 MHz band
  - Minimum gain = 7.8 dB @ 400 MHz
- Built–in matching network for broadband operation using double match technique
- 100% tested for load mismatch at all phase angles with 30:1 VSWR
- Gold metallization system for high reliability applications

Designed primarily for wideband large–signal output amplifier stages in the 225 to 400 MHz frequency range.

Product Image



CASE 316–01, STYLE 1

MAXIMUM RATINGS*

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	33	Vdc
Collector–Base Voltage	V_{CBO}	60	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Total Device Dissipation @ T_C = 25°C (1) Derate above 25°C	P_D	146 0.83	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.2	°C/W

ELECTRICAL CHARACTERISTICS* (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, I_B = 0)	$V_{(BR)CEO}$	33	—	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	60	—	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 5.0 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current (V_{CB} = 30 Vdc, I_E = 0)	I_{CBO}	—	—	2.0	mAdc

NOTE: (continued)

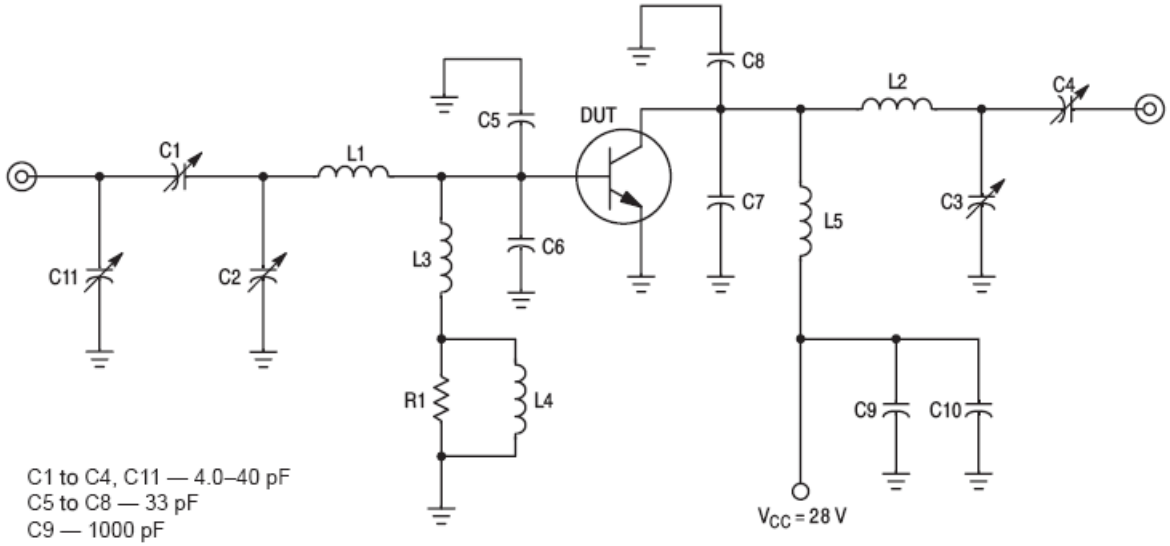
1. These devices are designed for RF operation. The total device dissipation rating applies only when the devices are operated as RF amplifiers.

* Indicates JEDEC Registered Data.

ELECTRICAL CHARACTERISTICS* — continued (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain (I_C = 1.0 Adc, V_{CE} = 5.0 Vdc)	h_{FE}	10	—	100	—
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 28 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	67	75	pF
BROADBAND FUNCTIONAL TESTS (Figure 6)					
Common–Emitter Amplifier Power Gain (V_{CC} = 28 Vdc, P_{out} = 60 W, f = 225–400 MHz)	G_{PE}	7.8	8.5	—	dB
Electrical Ruggedness (P_{out} = 60 W, V_{CC} = 28 Vdc, f = 400 MHz, VSWR 30:1 all phase angles)	ψ	No Degradation in Output Power			—
NARROW BAND FUNCTIONAL TESTS (Figure 1)					
Common–Emitter Amplifier Power Gain (V_{CC} = 28 Vdc, P_{out} = 60 W, f = 400 MHz)	G_{PE}	7.8	10	—	dB
Collector Efficiency (V_{CC} = 28 Vdc, P_{out} = 60 W, f = 400 MHz)	η	55	—	—	%

* Indicates JEDEC Registered Data.



C1 to C4, C11 — 4.0–40 pF
C5 to C8 — 33 pF
C9 — 1000 pF
C10 — 5.0 μF
R1 — 15 Ω
L1, L2 — 3/16″ x 1″ Copper Strap
L3 — 1.5 μH
L4 — 10 μH
L5 — 1 Turn #16 AWG, 5/16″ I.D.

Figure 1. 400 MHz Test Amplifier (Narrow Band)

NARROW BAND DATA

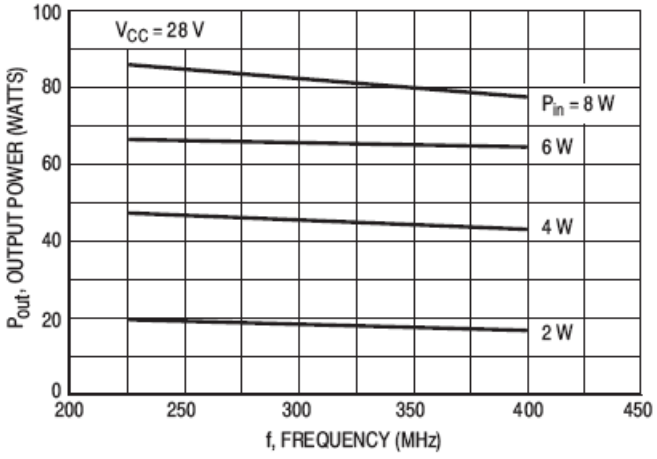


Figure 2. P_{out} versus Frequency

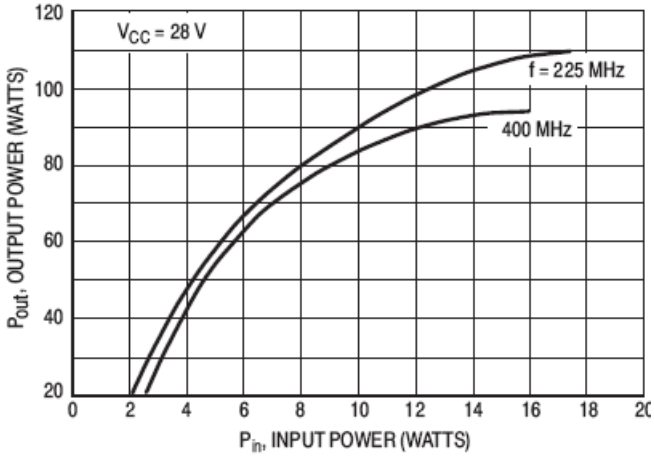


Figure 3. Output Power versus Input Power

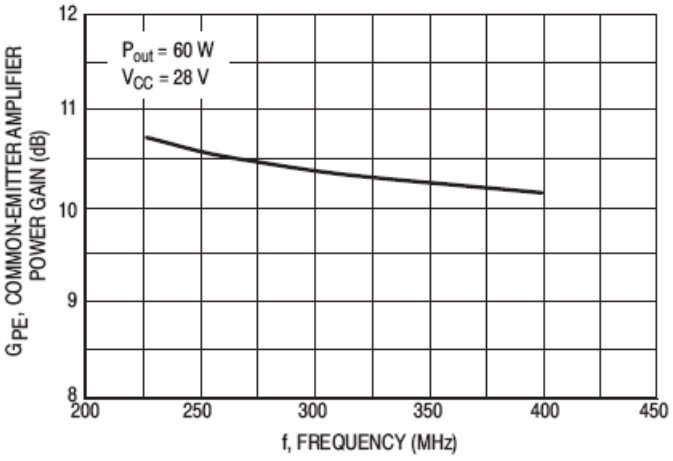


Figure 4. Power Gain versus Frequency

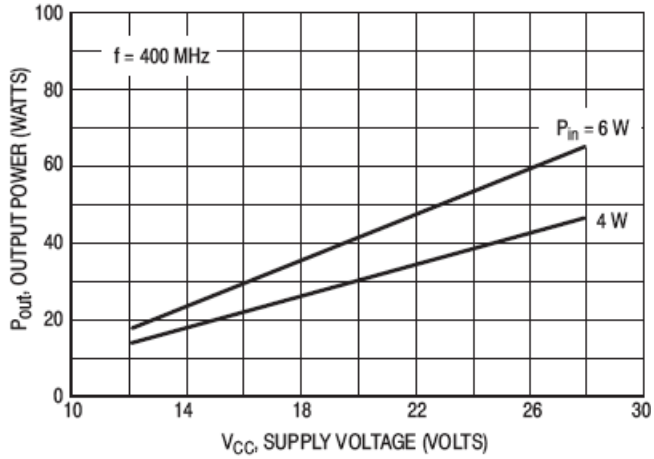


Figure 5. Output Power versus Supply Voltage

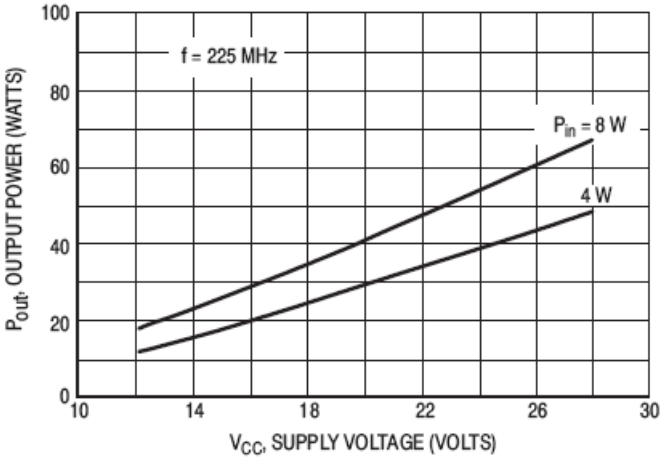
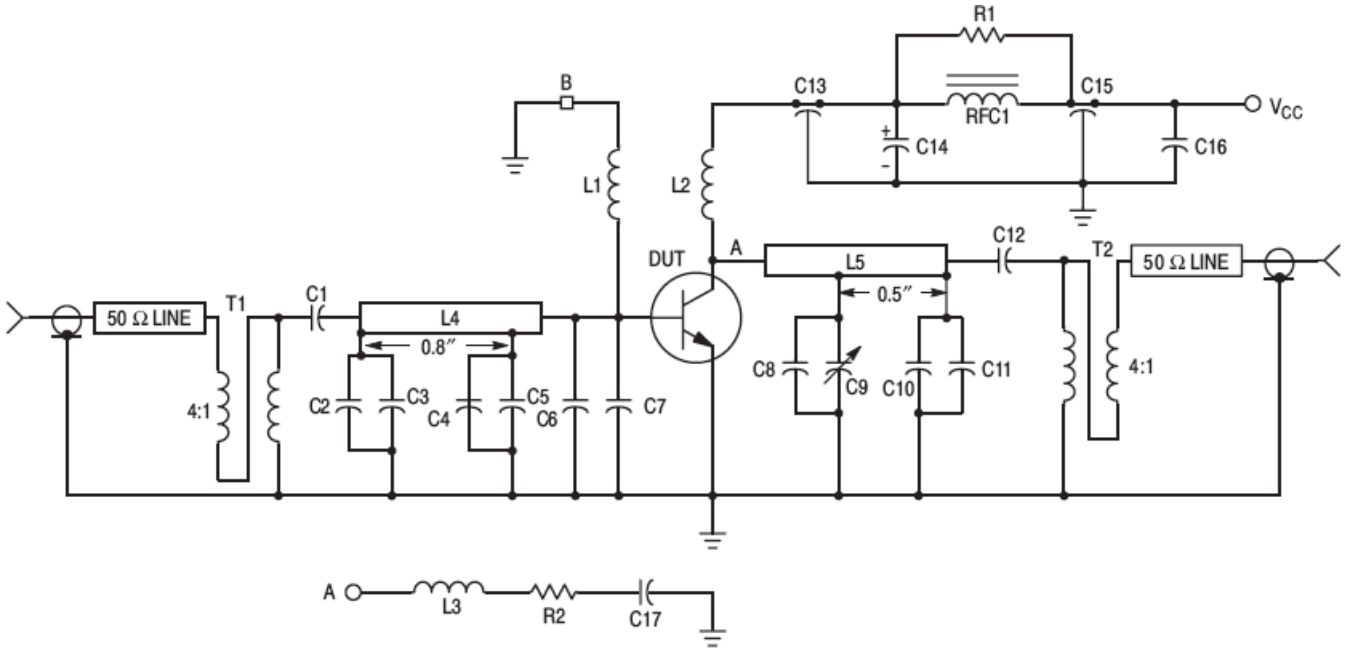


Figure 6. Output Power versus Supply Voltage



C1 — 68 pF
C2, C4, C8, C10 — 27 pF
C3, C5, C11 — 10 pF
C6, C7 — 51 pF
C9 — 1.0–10 pF JOHANSON
C12 — 100 pF
C13, C15 — 680 pF
C14, C16 — 1.0 µF, 35 V Tantalum
C17 — 0.1 µF, ERIE Red Cap

RFC1 — Ferrite Bead Choke, Feroxcube VK200 19/4B
B — Ferroxcube 56-590-65/4B Ferrite Bead
T1, T2 — 25 Ohms (UT25) Miniature Coaxial Cable, 1 turn
R1 — 11 Ω, 1.0 W
R2 — 20 Ω, 1/4 W
L1 — 10 Turns, #22 AWG, 1/8″ I.D.
L2 — 4 Turns, #16 AWG, 1/4″ I.D.
L3 — 6 Turns, #24 AWG, 1/8″ I.D.
L4, L5 — 1″ x 0.25″ Microstrip Line
Board Material 0.031″ Thick Teflon-Fiberglass

Figure 7. 225 to 400 MHz Broadband Test Circuit Schematic

BROADBAND DATA (Circuit, Figure 7)

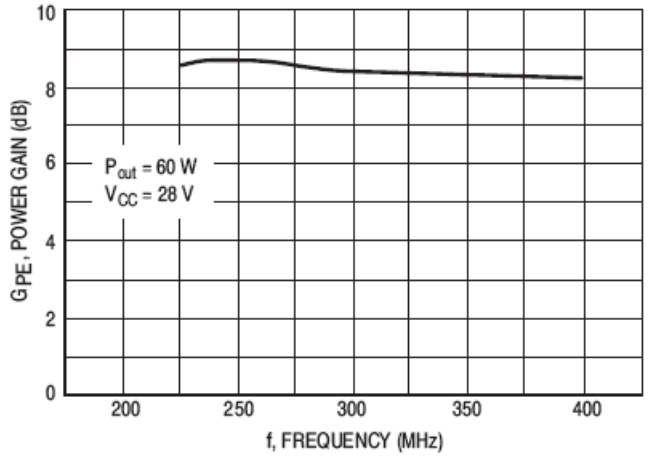


Figure 8. Power Gain versus Frequency

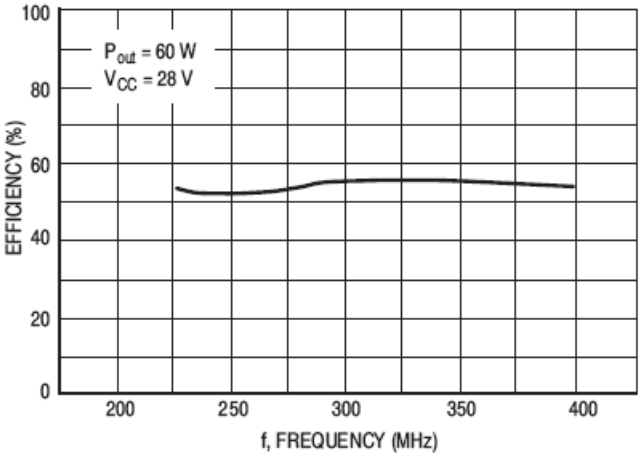


Figure 9. Efficiency versus Frequency

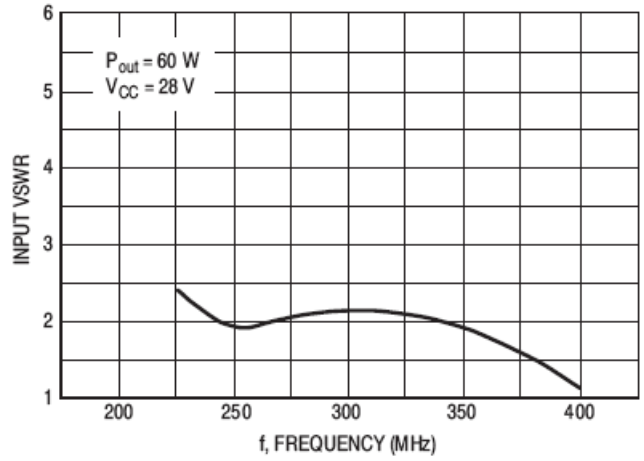
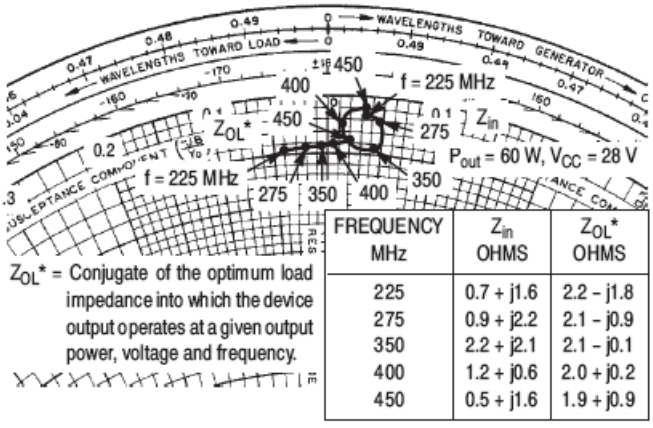


Figure 10. Input VSWR versus Frequency



FREQUENCY MHz	Z_{in} OHMS	Z_{OL}^* OHMS
225	0.7 + j1.6	2.2 – j1.8
275	0.9 + j2.2	2.1 – j0.9
350	2.2 + j2.1	2.1 – j0.1
400	1.2 + j0.6	2.0 + j0.2
450	0.5 + j1.6	1.9 + j0.9

Figure 11. Series Equivalent Input-Output Impedance

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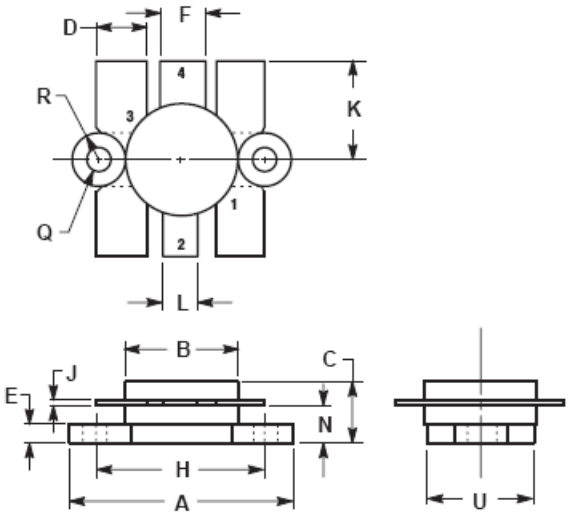
Rev. V1

PACKAGE DIMENSIONS



NOTES:
1. FLANGE IS ISOLATED IN ALL STYLES.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	24.38	25.14	0.960	0.990
B	12.45	12.95	0.490	0.510
C	5.97	7.62	0.235	0.300
D	5.33	5.58	0.210	0.220
E	2.16	3.04	0.085	0.120
F	5.08	5.33	0.200	0.210
H	18.29	18.54	0.720	0.730
J	0.10	0.15	0.004	0.006
K	10.29	11.17	0.405	0.440
L	3.81	4.06	0.150	0.160
N	3.81	4.31	0.150	0.170
Q	2.92	3.30	0.115	0.130
R	3.05	3.30	0.120	0.130
U	11.94	12.57	0.470	0.495

STYLE 1:
PIN 1. EMITTER
2. COLLECTOR
3. EMITTER
4. BASE

CASE 316–01
ISSUE D